



TRANSMITTAL FORM

Electronic Version 1.0.3

Stylesheet Version: 1.0

Attorney Docket
Number:

39.002-
AG

Submission Type: Utility Patent
Filing

WAFER INCLUDING AN In- CONTAINING-COMPOUND SEMICONDUCTOR SURFACE LAYER, AND METHOD FOR PROFILING ITS CARRIER CONCENTRATION

First Named Inventor: Mr. Shigeru Sawada

SUBMITTED BY

Name: James Judge
Registration Number: 42,701
Electronic Signature Mark: <jj>UDGE
Date Signed: 20021030

I certify that the use of this system is for OFFICIAL correspondence between patent applicants or their representatives and the USPTO. Fraudulent or other use besides the filing of official correspondence by authorized parties is strictly prohibited, and subject to a fine and/or imprisonment under applicable law.

I, the undersigned, certify that I have viewed a display of document(s) being electronically submitted to the United States Patent and Trademark Office, using either the USPTO provided style sheet or software, and that this is the document(s) I intend for initiation or further prosecution of a patent application noted in the submission. This document(s) will become part of the official electronic record at the USPTO.

Attached Files:

declaration	Declaration1.tif
declaration	Declaration2.tif
declaration	Declaration3.tif
specification	SM001spec.xml
bibd-transmittal	SM001apds.xml
patent-assignments	SM001asgn.xml
fee-transmittal	SM001fee.xml

Attached Image File(s):

Declaration1.tif
Declaration2.tif
Declaration3.tif

Comments:

FEE TRANSMITTAL



Electronic Version 1.1.0

Stylesheet Version: 1.0

Patent fees are subject to annual revisions on or about October 1st of each year.

Large Entity

TOTAL FEES AUTHORIZED: \$ 780

BANK (CREDIT) CARD INFORMATION:

Credit Card Number: 7147
Expiration Date: 20031031
Authorized Name: JAMES JUDGE
Billing Address: 99999

BASIC FILING FEE

Fee Description	Fee Code	Fee Paid
Utility Filing Fee	1001	\$ 740

Subtotal For Basic Filing Fee: \$ 740

EXTRA CLAIM FEES

	Fee Code	Fee	Extra Claims	Fee Paid
Total Claims: 13	1202	\$ 18	0	\$ 0
Independent Claims: 3	1201	\$ 84	0	\$ 0

Subtotal For Extra Claims Fees: \$ 0

ADDITIONAL FEES

Fee Description	Number	Quantity	Fee Code	Amount	Fee Paid
Recording Each Patent Assignment Per Property Fee	00000000	1	8021	\$ 40	\$ 40

Subtotal For Additional Fees: \$ 40

Electronic Filing System (EFS) Data
Electronic Patent Application Submission
USPTO Use Only

EFS ID: 19321
Application ID: 10065552
Title of Invention: WAFER INCLUDING AN In-CONTAINING-COMPOUND SEMICONDUCTOR SURFACE LAYER, AND METHOD FOR PROFILING ITS CARRIER CONCENTRATION
First Named Inventor: Shigeru Sawada
Domestic/Foreign Application: Domestic Application
Filing Date: null
Effective Receipt Date: 2002-10-29
Submission Type: Utility Patent Filing
Filing Type: new-utility
Confirmation Number: 0
Attorney Docket Number: 39.002-AG
Digital Certificate Holder: cn=James Judge, ou=Registered Attorneys, ou=Patent and Trademark Office, ou=Department of Commerce, o=U.S. Government, c=US
Certificate Message Digest: yPhzrvzHRwPrhV4v1OOaSw==
Total Fees Authorized: \$780.0
Payment Category: CC - Credit Card
Credit Card Number: *****7147
Expiration Date: 10312003
Card Holder Name: JAMES JUDGE
RAM User ID: EFSPROD
RAM Accounting Date: 2002-10-29
RAM Sequence Number: 554967
RAM Payment Status: RAM success

10065552 . 102902

Postal Code: 99999

Figures